

Ceramic Lids for RF and Microwave Packaging(Cer-Lids)

Ultra thin, enabling devices to become smaller in size, lower in height

Material Type: A-95 (Aluminum Oxide)

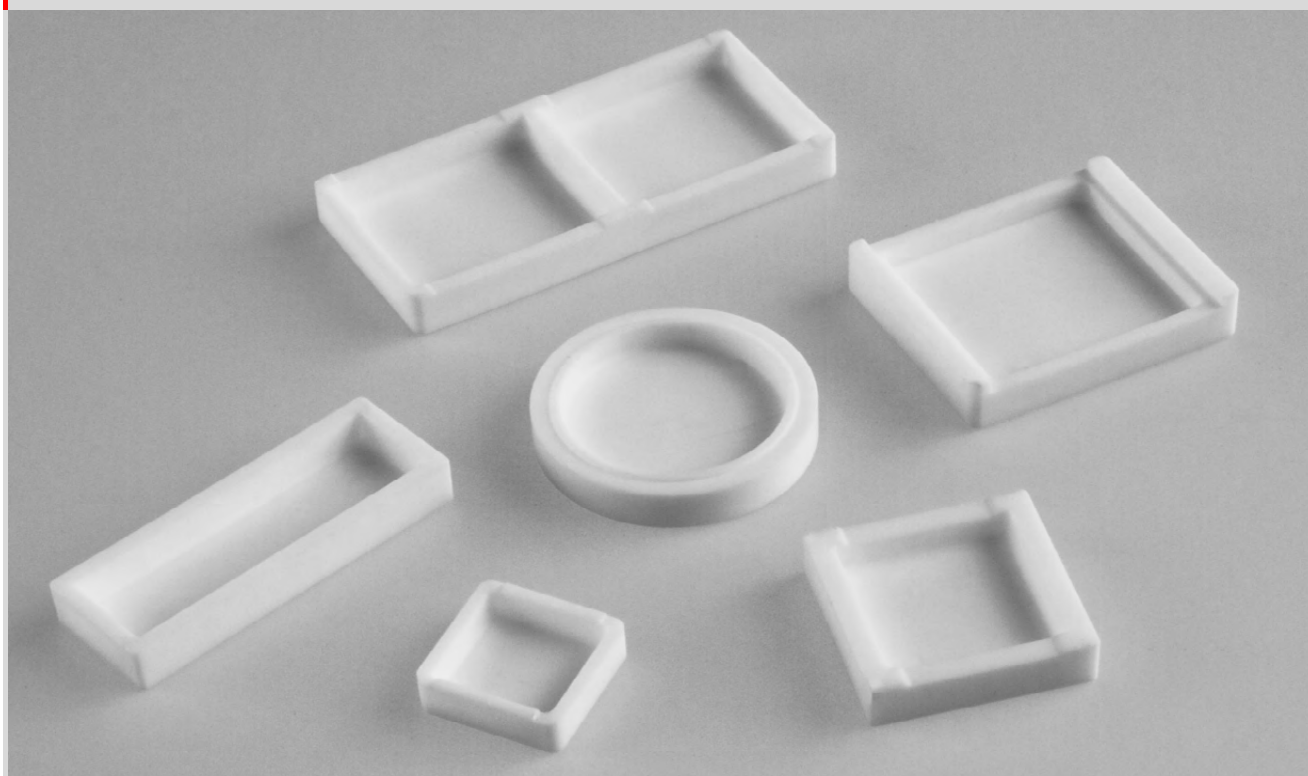
Color: White and Black

Features

Lids in ceramic for smaller size and lower height

Ultra thin walls, based on XMCera's unique material and forming technology

Cer-Lids



Applications for Ultra Thin Ceramic Lids(Cer-Lids)

MEMS Packaging

Semiconductor

Medical

Optical

Non-magnetic Applications

High Reliability Hermetic Package Sealing

Non-hermetic Packages

XMCera offer ceramic lids(Cer-Lids) that complement our ceramic packages for RF power transistors